



Recommended P.C.B. Layout
Layout tolerance = ±0.05 mm

MSDC-W20PA04-11-LF
LEADFREE

RoHS Compliant

- Notes :
- Material :
 - Housing : Thermoplastic , UL 94V-0
 - Ejector : Thermoplastic , UL 94V-0
 - Shell : Stainless steel
 - Terminal : Copper alloy
 - Detect Switch : Copper alloy
 - Receive Switch : Copper alloy
 - Lock Pin : Copper alloy
 - Spring : SWP
 - Bar : Stainless steel

- Finish :
 - Shell : Gold flash on solder area
 - Terminal : Selected gold on contact area, Gold flash on solder tail , 40u" min. Ni under-plated overall
 - Detect switch : Gold flash over 40u" min. Ni under-plated overall
 - Receive switch : Gold flash over 40u" min. Ni under-plated overall
 - Spring : 40u" min. Ni overall
 - Lock pin : 40u" min. Ni overall
- Terminal and nail Coplanarity : 0.1 mm Max.
- It must have 0.15 mm height space over "A" area

B			PART NO. MSDC-W20PA04-11		TOLERANCES ARE	DESCRIPTION:	MINI SD CARD CONN PUSH PUSH TYPE (H:2.2)			
			DWG NO. MSDC-W20PA04-11							CHECKED BY CY
A			FILE NO.		DRAWING BY	.X ± 0.2 .XX ± .XXX ± AWG	AREA	REVISIONS	HK	DATE
			UNIT / mm	SCALE 1:1	PROJECTION					